

Hi-Rel DC/DC CONVERTER MGDM-100: 100W POWER

Hi-Rel Grade ■■

10:1 Ultra Wide Input Single Output Metallic Case - 1.500 VDC Isolation

PRELIMINARY

Chindren FRAME

• 28Vdc input compliant with MIL-STD-1275

- Nominal power up to 100 W
- High efficiency (typ. 88%)
- Soft start
- Galvanic isolation 1.500 VDC
- Integrated LC input filter
- Permanent short circuit protection
- External synchronisation
- External trim and sense adjustment: +/-5%
- No optocoupler for high reliability

1-General

The MGDM-100 wide input series is a full family of DC/DC power modules designed for aerospace, military and high-end industrial applications. These modules use a high frequency fixed swiching technic at 250KHz providing excellent reliability, low noise characteristics and high power density. Standard models are available with ultra wide input voltage range of 10.7-100 volts covering the entire range of airborne or groundborne requirements. The serie includes single output voltage choices of 3.3, 5, 12, 15 volts.

All the modules are designed with LC network filters to minimize reflected input current ripple and output voltage ripple .

The modules include a soft-start, an input undervoltage and overvoltage lock-out, a permanent short circuit protection and an output overvoltage protection to ensure efficient module protections. The soft-start allows current limitation and eliminates inrush current during start-up. The short circuit protection completely protects the modules against short-circuits of any duration by a shut-down and restores to normal when the overload is removed.

The design has been carried out with surface mount components and is manufactured in a fully automated process to guarantee high quality. Each module is tested with a GAIA Converter automated test equipment.

2-Product Selection

Single output model : MGDS-100- (/T) and/or (/S)

Permanent Transient

M : 10.7-100 VDC n/a

Output

A: 2.5 VDC
B: 3.3 VDC
C: 5 VDC
E: 12 VDC
F: 15 VDC
I: 24 VDC
For lower output voltage below 2.5V please consult factory

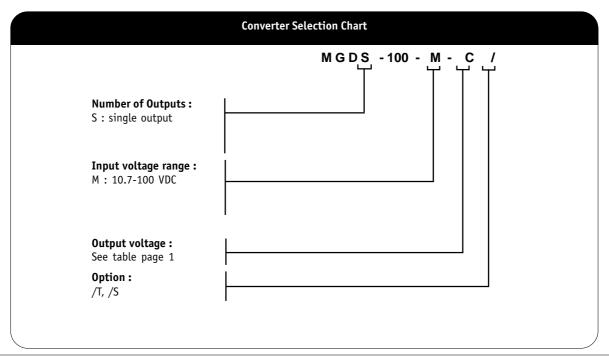
REDEFINING THE SOURCE OF POWER





2- Product Selection (continued)

Input range	Output	Current	Reference	Options
10.7-100 VDC	2,5 VDC	30 A	MGDS-100-M-A	/T, /S
10.7-100 VDC	3,3 VDC	30 A	MGDS-100-M-B	/T, /S
10.7-100 VDC	5 VDC	20 A	MGDS-100-M-C	/T, /S
10.7-100 VDC	12 VDC	8,25 A	MGDS-100-M-E	/T, /S
10.7-100 VDC	15 VDC	6,5 A	MGDS-100-M-F	/T, /S
10.7-100 VDC	24 VDC	4 A	MGDS-100-M-I	/T, /S







3- Electrical Specifications

Data are valid at +25°C, unless otherwise specified.

Parameter	Conditions	Limit or typical	Units	MGDS-100-M Single Output
Input				
Nominal input voltage	Full temperature range	Nominal	VDC	28
Permanent input **** voltage range (Ui)	Full temperature range	Min Max.	VDC	10.7-100
Transient input voltage	Full load (Consult factory)	Maximum	VDC/S	TBD
Undervoltage lock-out	Turn-on voltage	Nominal	VDC	10.5
(UVLO)	Turn-off voltage	Nominal	VDC	9.5
Overvoltage lock-out	Turn-on voltage	Nominal	VDC	72
(0VL0)	Turn-off voltage	Nominal	VDC	104
Start up time	Ui nominal within 3 ms Nominal output Full load : resistive	Maximum	ms	30
Reflected ripple current	Ui nominal, full load at switching freq. BW = 20MHz	Maximum	mApp	TBD
No load input power	Ui min. to max. No load	Maximum	W	5
Standby input power	Ui min. to max. No load	Maximum	W	1
Output				
Output voltage *	Full temperature range Ui min. to max. 75% load	Nominal Nominal Nominal Nominal Nominal	VDC VDC VDC VDC VDC	2,5 3,3 5 12 15
Set Point accuracy *	Ambient temperature : +25°c Ui nominal, 75% load	Nominal Maximum	VDC %	24 +/- 2
Output power **	Full temperature range Ui min. to max.	Maximum	W	see curves section 10
Output current ** 3,3V and 2,5 output 5V output 12V output 15V output 24V output	Full temperature range Ui min. to max.	Maximum Maximum Maximum Maximum Maximum	A A A A	30 20 8,25 6,5 4
Ripple output voltage *** 2,5, 3,3V and 5V output 12V output 15V output 24V output	Ui nominal Full load BW = 20MHz	Maximum Maximum Maximum Maximum	mVpp mVpp mVpp mVpp	50 100 150 250
Output regulation* (Line + load + thermal)	Ui min. to max. 0% to full load	Maximum	%	+/- 1
output Voltage Trim	As a function of output voltage	Minimum Maximum	% %	80 110
Efficiency	Ui nominal Full load	Typical	%	88

Note *: These performances are measured with the sense line connected.

Note **: It is recommended to mount the converter on a heatsink for this test, see section 10 for further details.

Note ***: The ripple output voltage is the periodic AC component imposed on the output voltage, an aperiodic and random component (noise) has also to be considered. This noise can be reduced by adding 1 external decoupling capacitor connected between Gin and Gout. These capacitance should be layed-out as close as possible from the converter. The ripple output voltage is measured by connecting a ceramic chip capacitor C accross Vo and Go pins (C=100µF if Vo<5Vdc C=10µF if Vo>5Vdc). Note ****: From 50V to 100V a minimum load of 20W is required otherwise the converter falls in hiccup mode.





3- Electrical Characteristics (continued)

Figure 1: Typical efficiency versus load at various input

Figure 2 : Typical efficiency versus load at various input

Figure 3 : Typical efficiency versus load at various input

Figure 4: Typical load regulation characteristics at nominal input

Figure 5 : Typical load regulation characteristics at nominal input

Figure 6 : Typical load regulation characteristics at nominal input





4- Switching Frequency

Parameter	Conditions	Limit or typical	Specifications
Switching frequency	Full temperature range Ui min. to max. No load to full load	Nominal, fixed	260 KHz

5- Isolation

Parameter	Conditions	Limit or typical	Specifications
Electric strength test voltage "M" input range	Input to output	Minimum	1.500 VDC / 1 min
Isolation resistance	500 VDC	Minimum	100 M0hm

6- Protection Functions

Characteristics	Protection Device	Recovery	Limit or typical	Specifications
Input undervoltage lock-out (UVL0)	Turn-on, turn-off circuit with hysteresis cycle	Automatic recovery	Turn-on nominal Turn-off nominal	See section 3
Input overvoltage lock-out (OVLO)	Turn-on, turn-off circuit with hysteresis cycle			See section 3
Output current limitation protection (OCP)	Straight line current limitation	Automatic Nominal recovery		130%
Output overvoltage protection (OVP)	Overvoltage protection limitation	Automatic recovery Min max.		120% +/-5% of output voltage
Over temperature protection (OTP)	Thermal device with hysteresis cycle	Automatic recovery	Nominal	115°C

7- Reliability Data

Characteristics	Conditions	Temperature	Specifications
Mean Time Between Failure (MTBF)	Ground fixed (Gf)	Case at 40°C Case at 70°C	Consult factory
According to MIL-HDBK-217F	Ground mobile (Gm)	Case at 40°C Case at 70°C	Consult factory
Mean Time Between Failure (MTBF) According to IEC-62380-TR	Telecom switchers	/	Consult factory





8- Electromagnetic Interference

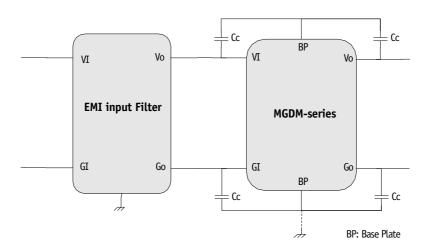
Electromagnetic Interference requirements according to MIL-STD-461C/D/E standards can be easily achieved as indicated in the following section. The following table resumes the different sections covered by these standards.

Standard Requirements	MIL-STD-461C Standard	MIL-STD-461D/E Standard	Compliance with GAIA Converter Module & common mode capacitance
Conducted emission (CE) : Low frequency High frequency	CE 01 CE 03	CE 101 CE 102	compliant module stand-alone compliant with additionnal filter
Conducted susceptibility (CS) : Low frequency High frequency	CS 01 CS 02	CS 101 CS114	compliant with additionnal filter compliant with additionnal filter
Radiated emission (RE) : Magnetic field Electrical field	RE 01 RE 02	RE 101 RE 102	compliant module stand-alone compliant module stand-alone
Radiated susceptibility (RS) : Magnetic field Electrical field	RS 01 RS 03	RS 101 RS 103	compliant module stand-alone compliant module stand-alone
Applicability	M input module	M input module	see EMI datasheet

8-1 Module Compliance with MIL-STD-461C/D/E Standards

To meet the latest US military standards MIL-STD-461D/E (and also the MIL-STD-461C) requirements and in particular the conducted noise emission CE102 (and also CE03) requirements, Gaïa Converter can propose a stand-alone ready-to-use EMI filter module. This EMI filter module has to be used together with a common mode noise capacitance C_c (10nF/rated voltage depending on isolation requirement) connected between Gin and Gout.

Please consult EMI filter datasheet for further details.







10- Thermal Characteristics

Characteristics	Conditions	Limit or typical	Performances
Operating ambient temperature range	Ambient temperature *	Minimum Maximum	NA
Operating case temperature range at full load	Case temperature	Minimum Maximum	- 40°C see curve below
Storage temperature range	Non functionning	Minimum Maximum	- 40°C + 115°C
Thermal resistance	Rth case to ambient in free air natural convection	Typical	7°C /W

Note *: The upper temperature range depends on configuration, the user must assure a max. case temperature of conform with curve.

Heat can be removed from the MGDM-100 case via three basic mechanisms :

- Radiation transfert : radiation is counting for less than 5% of total heat transfert in majority of case, for this reason the presence of radient cooling is used as a safety margin and is not considered.
- Conduction transfert: in most of the applications, heat will be conducted from the baseplate into an attached heatsink or heat conducting member; heat is conducted thru the interface.
- Convection transfert : convecting heat transfer into air refers to still air or forced air cooling.

In majority of the applications, heat will be removed from the case either with :

- heatsink,
- · forced air cooling,
- both heatsink and forced air cooling.

To calculate a maximum admissible ambient temperature the following method can be used.

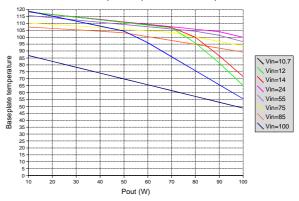
Knowing the power used Pout and the efficiency η :

• determine the power dissipated by the module Pdiss that should be evacuated :

Pdiss = Pout
$$(1/\eta - 1)$$
 (A)

Knowing the maximum baseplate temperature Tbase of the module as indicated in the following curve:





determine the maximum ambient temperature:
 Ta = Tbase - Rth(b-a) x Pdiss (B)
 where Rth(b-a) is the thermal resistance from the case to ambient.

This thermal Rth(b-a) resistance is the summ of:

- the thermal resistance of baseplate to heatsink (Rth(b-h)). The interface between baseplate and heatsink can be nothing or a conducting member, a thermal compound, a thermal pad.....
- the thermal resistance of heatsink to ambient air (Rth(h-a)), which is depending of air flow and given by heatsink supplier.

The table hereafter gives some example of thermal resistance for different heat transfert configurations.

Heat transfert	Thermal resistance heatsink to air Rtl	h(h-a)	Thermal resistance heatsin		Global resistance
Free air cooling	No Heatsink baseplate only :	7°C/W	No need of thermal pad		7°C/W
only	Heatsink Aavid Thermalloy 824353B03000	4,1°C/W	Berquist Silpad*:	0,13°C/W	4,23°C/W
Forced air cooling	No Heatsink baseplate only :	4,4°C/W	No need of thermal p	ad	4,4°C/W
200 LFM	Heatsink Aavid Thermalloy 824353B03000	2,2°C/W	Berquist Silpad* :	0,13°C/W	2,33°C/W
Forced air cooling	No Heatsink baseplate only :	3,1°C/W	No need of thermal p	ad	3,1°C/W
400 LFM	Heatsink Aavid Thermalloy 824353B03000	1,6°C/W	Berquist Silpad* :	0,13°C/W	1,73°C/W
Forced air cooling	oling No Heatsink baseplate only :		No need of thermal p	ad	1,8°C/W
1000 LFM	Heatsink Aavid Thermalloy 824353B03000	1°C/W	Berquist Silpad*:	0,13°C/W	1,13°C/W

Aavd Thermalloy is a heasink manufacturers. «Silpad» © is a registered trademark of Berquist. Note*: Silpad performance are for Silpad 400 with pressure conditions of 50 Psi.





10- Thermal Characteristics (continued)

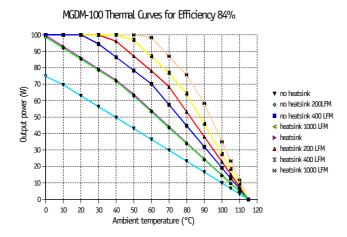
The two formulas (A) and (B) described in previous page:

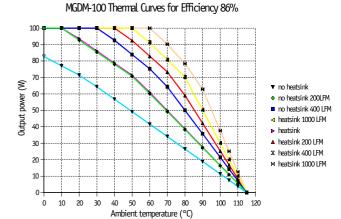
- Pdiss = Pout(1/η 1) (A)
 Ta = Tbase Rth(b-a) x Pdiss (B)
- conduct to curves determining the ambient temp

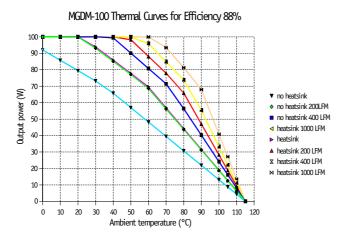
conduct to curves determining the ambient temperature admissible as a function of output power for various heat transfert conditions.

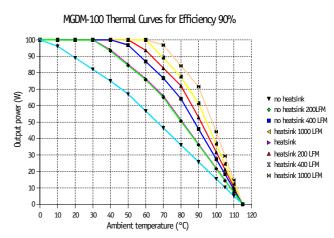
In particular, as example the following typical curves are calculated with :

- no heatsink
- a Thermaflo heatsink reference 824353B03000 and
- a Berquist «Silpad» for various cooling conditions.













10- Environmental Qualifications

The modules have been subjected to the following environmental qualifications.

Characteristics	Conditions	Severity	Test procedure
Climatic Qualification	ns		
Life at high temperature	Duration Temperature / status of unit	Test D: 1.000 Hrs @ 105°C case, unit operating @ 125°C ambient, unit not operating	MIL-STD-202G Method 108A
Altitude	Altitude level C Duration Climb up Stabilization Status of unit	40.000 ft@-55°C 30 min. 1.000 ft/min to 70.000 f@-55°C, 30 min. unit operating	MIL-STD-810E Method 500.3
Humidity cyclic	Number of cycle Cycle duration Relative humidity variation Temperature variation Status of unit	10 Cycle I: 24 Hrs 60 % to 88 % 31°C to 41°C unit not operating	MIL-STD-810E Method 507.3
Humidity steady	Damp heat Temperature Duration Status of unit	93 % relative humidity 40°C 56 days unit not operating	MIL-STD-202G Method 103B
Salt atmosphere	Temperature Concentration NaCl Duration Status of unit	35°C 5 % 48 Hrs unit not operating	MIL-STD-810E Method 509.3
Number of cycles Temperature thange Transfert time Steady state time Status of unit		200 -40°C / +85°C 40 min. 20 min. unit operating	MIL-STD-202A Method 102A
Temperature shock	Number of shocks Temperature change Transfert time Steady state time Status of unit	100 -55°C / +105°C 10 sec. 20 min. unit not operating	MIL-STD-202G Method 107G
Mechanical Qualifica	tions		
Vibration (Sinusoidal) Number of cycles Frequency / amplitude Frequency / acceleration Duration Status of unit		10 cycles in each axis 10 to 60 Hz / 0.7 mm 60 to 2000 Hz / 10 g 2h 30 min. per axis unit not operating	MIL-STD-810D Method 514.3
Shock (Half sinus)	Number of shocks Peak acceleration Duration Shock form Status of unit	3 shocks in each axis 100 g 6 ms 1/2 sinusoidal unit not operating	MIL-STD-810D Method 516.3
Bump (Half sinus)	Number of bumps Peak acceleration Duration Status of unit	2000 Bumps in each axis 40 g 6 ms unit not operating	MIL-STD-810D Method 516.3





12- Description of Protections

The MGDM-100 series include 5 types of protection devices.

12-1 Input Undervoltage Lockout (UVLO) and Overvoltage Lockout (OVLO)

12-1-1 Undervoltage Lockout (UVLO)

An input undervoltage protection will inhibit the module when input voltage drops below the lock-out turn-off threshold (see section 3 for value) and restores to normal operation automatically when the input voltage rises the lock-out turn-on threshold.

The input undervoltage lock-out threshold (UVLO) can be trimmed by connecting a resistor between UVLO anf Gi pins. This resistance can be calculated as folow:

$$R_{UVL0} = \underbrace{a \times (1 + b - n)}_{(n - 1)} \qquad \text{where } n = \underbrace{UVLO_{trim}}_{UVL0_{threshold}}$$

$$\underbrace{Input M}_{a \qquad 1000 \qquad b \qquad 13.2}$$

12-1-2 Overvoltage Lockout (OVLO)

An input overvoltage protection will inhibit the module when input voltage reaches the overvoltage lockout turn-off threshold (see section 3 for value) and restores to normal operation automatically when the input voltage drops below the overvoltage Lockout turn on threshold.

12-2 Output Over Current Protection (OCP)

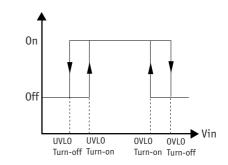
The MGDM-100 Series incorporates a straight line current limit and protection circuit. When the output current reaches 130% of it's full-rated current (Icurrent limit), the output voltage decreases down to 75% of nominal output voltage. Below this threshold the converter falls in hiccup mode by testing periodically if an overload is applied. The module restart automatically to normal operation when overcurrent is removed.

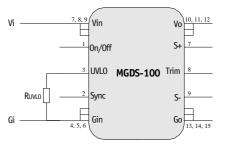
12-3 Output Overvoltage Protection (OVP)

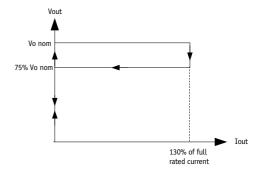
The MGDM-100 series has an internal overvoltage protection circuit that monitors the voltage accross the output power terminals. It is designed to limit the converter at 120% (+/-5%) of output voltage.

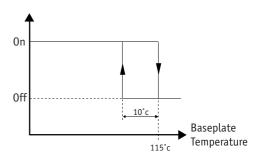
12-4 Over Temperature Protection (OTP)

A thermal protection device adjusted at 115°C (+/-5%) internal temperature with 10°C hysteresis cycle will inhibit the module as long as the overheat is present and restores to normal operation automatically when overheat is removed. The efficiency of the OTP function is warranty with the module mounted on a heatsink.













13- Description of Functions

13-1 Trim Function

The output voltage Vo may be trimmed in a range of 80%/110% of the nominal output voltage via a single external trimpot or fixed resistor.

Trim Up Function

Do not attempt to trim the module higher than 110% of nominal output voltage as the overvoltage protection may occur.

Also do not exceed the maximum rated output power when the module is trimmed up.

The trim up resistor must be connected to S+ pin.

The trim up resistance must be calculated with the following formula:

$$Ru = \frac{R1 (V0-Vref)V0_{nom}}{(V0-V0_{nom})Vref} - R1 - R2$$

Trim Down Function

Do not trim down more than -20% of nominal output voltage otherwise the module may turn off.

The available output power is reduced by the same percentage that output voltage is trimmed down.

The trim down resistor must be connected to S- pin.

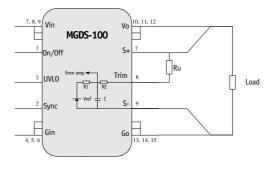
The trim down resistance must be calculated with the following formula:

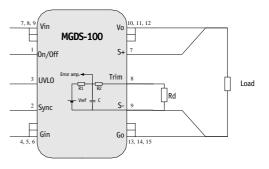
$$Rd = \frac{(R2 + R1)V0 - R2V0_{nom}}{V0_{nom}} - V0$$

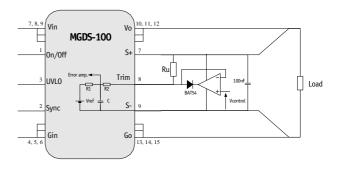
Trim via a voltage

The output voltage is given by the following formula:

$$V0 = (1 + \frac{R1}{(R1 + R2)} (\frac{Vcont}{Vref} - 1)) \times Vnom$$







Parameter	Unit	Min.	Тур.	Max.
Trim reference	Vdc	2,45	2,5	2,55
Resistor R1	Ohm	/	39K	/
Resistor R2	Ohm	/	270	/
Trim capacitor C	nF	/	10	/

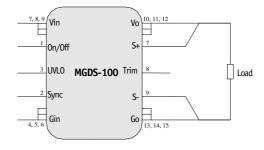




13- Description of Functions (continued)

13-2 Sense Function

If the load is separated from the output by any line lenght, some of these performance characteristics will be degraded at the load terminals by an amount proportional to the impedance of the load leads. Sense connections enable to compensate the line drop at a maximum of +/-10% of output voltage. The overvoltage protection will be activated and module will shut down if remote sense tries to boost output voltage above 120% of nominal output voltage. Connection is described in figure herein.

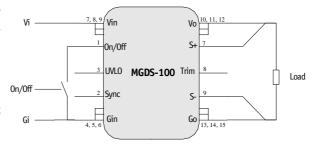


13-3 On/Off Function

The control pin 1 (On/Off) can be used for applications requiring On/Off operation. This may be done with an open collector transistor, a switch, a relay or an optocoupler. Several converters may be disabled with a single switch by connecting all On/Off pins together.

- The converter is disabled by pulling low the pin 1.
- No connection or high impedance on pin 1 enables the converter

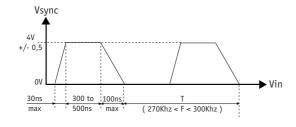
By releasing the On/Off function, the converter will restart within the start up time specifications given in table section 3

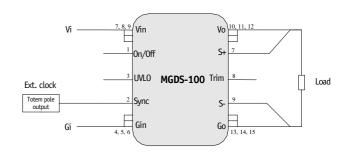


Parameter	Unit	Min.	Тур.	Max.	Notes, conditions
On/Off module enable voltage	Vdc	3.5	/	5	Open, the switch must not sink more than 100µA
On/Off module disable voltage	Vdc	0	/	0.5	The switch must be able to sink 1mA
On/Off alarm level	Vdc	0	/	0.5	OTP faulty module
On/Off module enable delay	ms	/	/	30	The module restarts with the same delay after alarm mode removed
On/Off module disable delay	μs	/	/	100	Vi nominal, full load

13-4 Synchronization Function

An external clock with pulse signals can be used to lock one or more converters. The external clock signal should have a frequency range from 270KHz to 300KHz, a low level below 0,5V a high level of 4V (+/-0.5V), a rise time of 30 ns max., a fall time of 100ns max., and a pulse width of 300 to 500 ns. Several converters can be synchronized by connecting their Sync pin together.







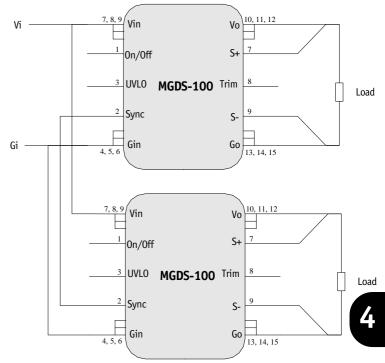
14- Application Notes

14-1 Synchronization of Modules

The MGDI-100 series provides a synchronization function trough the pin 2 (Synchro) to enable automatic synchronisation between several converters.

If several converters are used, they lock themselves into the highest switching frequency.

The synchronization signal available on pin 2 is referenced to ground in (Gi).

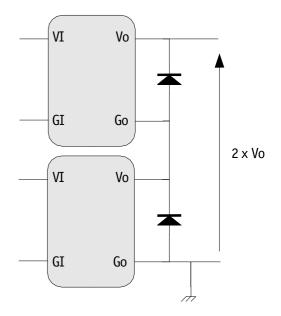


14-2 Connection of Modules in Series

The output of single output units can be connected in series without any precautions to provide higher output voltage

Nevertheless, GAIA Converter recommends to protect each individual output by a low power shottky diode rated with the maximum current of the converter to avoid reverse polarity at any output.

Reverse polarity may occur at start up if the output voltages do not rise at the same time.







15- PCB Mounting Specifications

The MGDM-100 series has been design for low profile applications.

Two levels of mounting can be designed:

- On-board mounting with 12,5 mm height
- In-board mounting with 10,5 mm height and PCB hole design on the mother board

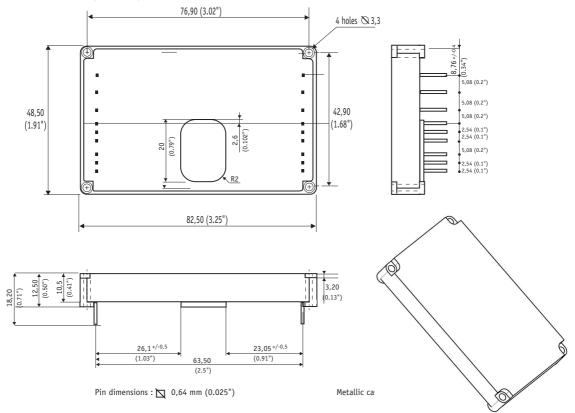






16- Dimensions

Dimension are given in mm (inches). Tolerance: \pm 0,2 mm (\pm 0.01 ") unless otherwise indicated. Weight: 65 grams (2.30 Ozs) max.

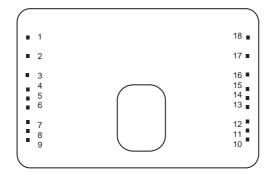


17- Product Marking

Upper face: Company logo, location of manufacturing.

Side face: Module reference, option, date code: year and week of manufacturing.

18- Connections



Pin	Single			
1	On / Off			
2	Synchro (Sync)			
3	UVLO			
4, 5, 6	- Input (Gi)			
7, 8, 9	+ Input (Vi)			
10, 11, 12	Output (Vo)			
13, 14,15	Common (Go)			
16	Sense +			
17	Trim			
18	Sense -			

Bottom view





For more detailed specifications and applications information, contact:

International Headquarters North American Headquarters

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